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| 10/598,142 | 08/18/2006 RULE | 228 | 1793 | P30470 | |
| APPLICANTS Masaru Shirai, Tokyo, JAPAN; Junichi Onozaki, Tokyo, JAPAN; Hiroshi Saito, Tokyo, JAPAN; Isao Sakamoto, Tokyo, JAPAN; Masahiko Furuno, Tokyo, JAPAN; Haruhiko Ando, Tokyo, JAPAN; Atsushi Hiratsuka, Tokyo, JAPAN; ** CONTINUING DATA ***** This application is a 371 of PCT/JP05/05909 03/29/2005 ** FOREIGN APPLICATIONS ***** JAPAN 2004/099888 03/30/2004 JAPAN 2004/102407 03/31/2004 ** IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 03/31/2007 | | | | | |
| Foreign Priority claimed <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No 35 USC 119(a-d) conditions met <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No Verified and /NICHOLAS P D'ANIELLO/ Acknowledged Examiner's Signature | | <input type="checkbox"/> Met after Allowance STATE OR COUNTRY JAPAN | SHEETS DRAWINGS 15 | TOTAL CLAIMS 35 | INDEPENDENT CLAIMS 4 |
| ADDRESS GREENBLUM & BERNSTEIN, P.L.C. 1950 ROLAND CLARKE PLACE RESTON, VA 20191 UNITED STATES | | | | | |
| TITLE Heater, reflow apparatus, and solder bump forming method and apparatus | | | | | |
| FILING FEE RECEIVED 1850 | FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following: | | <input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit | | |